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<td>.12</td>
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**Board Characteristics**

1. Materials can be changed as required by application.
2. Minimum trace width/gap: 0.205mm/0.3mm
3. 0.5 Oz Copper on all layers.
4. Silkscreen on component side.
5. Place Stiffener on top (component) side of flex PCB.
6. Stiffener size as per flex PCB.

**Layer Order**

- **2-Layer Flex PCB**
  - Film 1 = Component Side
  - Film 2 = Bottom

**Specification Drawing**

- DAMIC - Ext Flex PCB 1.5m
- UNIVERSITY OF CHICAGO ELECTRONICS DEVELOPMENT GROUP
- DRW 3010 A
- M. Bogdan

**Approval**

- Date: 9/20/2023
- Project: DAMIC

**Sheet Information**

- Sheet #: 1
- Title: 2-Layer Flex PCB
- Drawing Number: 3010 A
- Contract Number: 3010 A

**Board's Drill Schedule**

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